



Material Composition Declaration
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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

1752-21.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information
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Supplier Information

Company name* onsemi	Company unique ID	Unique ID Authority	Response Date* 2023-06-08
Contact Name Product-Env-Stewards	Title - Contact Product Enviro Compliance	Phone - Contact* NA	Email - Contact* Product-Env-Stewards@onsemi.com
Authorized Representative* Product-Env-Stewards	Title - Representative Product Enviro Compliance	Phone - Representative* NA	Email - Representative* Product-Env-Stewards@onsemi.com

Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type
	STK531U369A-E	Inverter	2023-06-08		VN2	14100.0	mg	Each

Manufacturing Process Information

Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles
Matte Tin (Sn) - annealed	CU Alloy	NA	0 C	30 seconds	3

Comments

For more information regarding material composition please refer to page 3

RoHS Material Composition Declaration		Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).		
<p>Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.</p>			
RoHS Declaration *	4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions		Supplier Acceptance * Accepted
Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.			
Exemption List Version	EL-2011/534/EU		
Declaration Signature			
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.			
Supplier Digital Signature	Rastislav Drska		

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	3930.48	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		49.131	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		193.7727	mg
			B	Nickel (Ni)	7440-02-0		6.6818	mg
			Supplier	Acrylic resins	Proprietary Data		2.7513	mg
			Supplier	Copper (Cu)	7440-50-8		264.1282	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7		1.9652	mg
			Supplier	Aluminum (Al)	7429-90-5		3412.0496	mg
Chip Parts	45.36	mg	Supplier	Silver (Ag)	7440-22-4		1.2338	mg
			Supplier	Epoxy resins	129915-35-1		0.4355	mg
			Supplier	Tin (Sn)	7440-31-5		1.3427	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		0.0635	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.7802	mg
			Supplier	Ceramic	12013-47-7, 12047-27-7		8.4642	mg
			Supplier	Phenolic resins	Proprietary Data		0.0544	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0045	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		27.7104	mg
			B	Nickel (Ni)	7440-02-0		2.2272	mg
			A	Lead Oxide (PbO)	1317-36-8	7c	0.0635	mg
			Supplier	Copper (Cu)	7440-50-8		2.6762	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.3039	mg
Die	30.06	mg	Supplier	Silicon (Si)	7440-21-3		30.06	mg
Die Attach	1.62	mg	Supplier	Silver (Ag)	7440-22-4		1.1034	mg
			Supplier	Other Epoxy resins	Proprietary Data		0.2435	mg
			Supplier	Tin (Sn)	7440-31-5		0.1714	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0616	mg
			B	Antimony (Sb)	7440-36-0		0.0159	mg
			B	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0243	mg
Heat Sink	869.5	mg	Supplier	Silver (Ag)	7440-22-4		139.12	mg
			Supplier	Copper (Cu)	7440-50-8		730.38	mg
Lead Frame	527.07	mg	Supplier	Tin (Sn)	7440-31-5		0.3162	mg
			Supplier	Copper (Cu)	7440-50-8		526.7538	mg

Mold Compound-Black	8586.38	mg		Brominated epoxy resin	proprietary data		18.89	mg
			Supplier	Phenolic Resin	Proprietary Data		443.0572	mg
			B	Antimony Trioxide (Sb2O3)	1309-64-4		13.7382	mg
			Supplier	Carbon Black (C)	1333-86-4		35.2042	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		609.633	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5712.5186	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		944.5018	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		808.837	mg
Plating	1.05	mg	Supplier	Tin (Sn)	7440-31-5		0.6501	mg
			B	Nickel (Ni)	7440-02-0		0.3999	mg
Solder Ball	19.87	mg	Supplier	Silver (Ag)	7440-22-4		0.5544	mg
			Supplier	Tin (Sn)	7440-31-5		19.2024	mg
			B	Antimony (Sb)	7440-36-0		0.0159	mg
			Supplier	Copper (Cu)	7440-50-8		0.0974	mg
Wire Bond - Al	88.61	mg	Supplier	Aluminum (Al)	7429-90-5		88.61	mg